

v06.0514



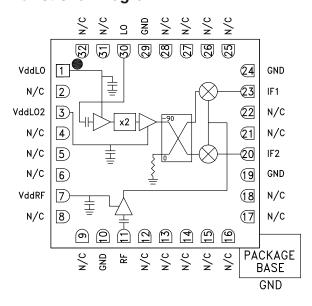
GaAs MMIC I/Q DOWNCONVERTER 24 - 28 GHz

Typical Applications

The HMC572LC5 is ideal for:

- Point-to-Point and Point-to-Multi-Point Radio
- Military Radar, EW & ELINT
- Satellite Communications

Functional Diagram



Features

8 dB Conversion Gain Image Rejection: 18 dB 2 LO to RF Isolation: 35 dB

Noise Figure: 3.5 dB Input IP3: +5 dBm

32 Lead 5x5mm SMT Package: 25mm²

General Description

The HMC572LC5 is a compact GaAs MMIC I/Q downconverter in a leadless RoHS compliant SMT package. This device provides a small signal conversion gain of 8 dB with a noise figure of 3.5 dB and 18 dB of image rejection across the frequency band. The HMC572LC5 utilizes an LNA followed by an image reject mixer which is driven by an active x2 multiplier. The image reject mixer eliminates the need for a filter following the LNA, and removes thermal noise at the image frequency. I and Q mixer outputs are provided and an external 90° hybrid is needed to select the required sideband. The HMC572LC5 is a much smaller alternative to hybrid style image reject mixer downconverter assemblies, and it eliminates the need for wire bonding by allowing the use of surface mount manufacturing techniques.

Electrical Specifications, $T_A = +25$ °C, IF = 100 MHz, LO = +4 dBm, Vdd = 3.5 Vdc*

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, RF	24.5 - 26.5			23 - 28			GHz
Frequency Range, LO	9 - 15.5			9 - 15.5			GHz
Frequency Range, IF	DC - 3.5			DC - 3.5			GHz
Conversion Gain (As IRM)	6.0	8.0		6	10		dB
Noise Figure		3.5			3.5		dB
Image Rejection	14	17		14	20		dB
1 dB Compression (Input)	-6	-4		-7	-5		dBm
2 LO to RF Isolation	32	35		30	35		dB
2 LO to IF Isolation	30	40		25	40		dB
IP3 (Input)	+5	+8		+3	+6		dBm
Amplitude Balance		0.3			0.4		dB
Phase Balance		5			8		Deg
Total Supply Current		125	165		125	165	mA

^{*}Data taken as IRM with external IF Hybrid





Data Taken As IRM With External IF Hybrid

Conversion Gain vs. Temperature

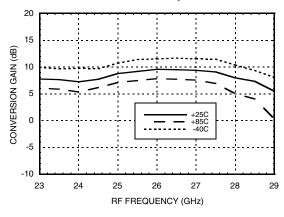
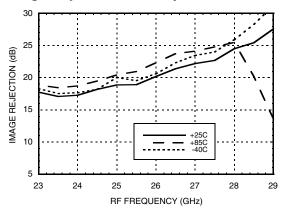
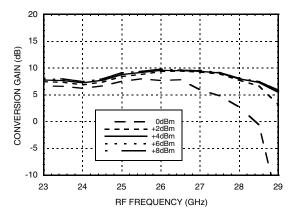


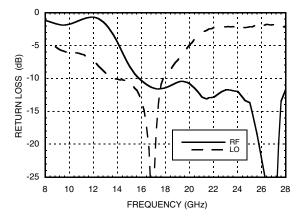
Image Rejection vs. Temperature



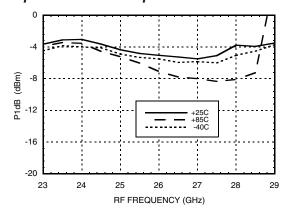
Conversion Gain vs. LO Drive



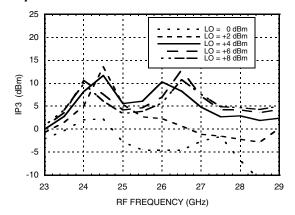
Return Loss



Input P1dB vs. Temperature



Input IP3 vs. LO Drive

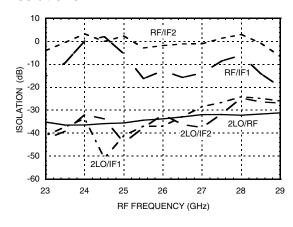




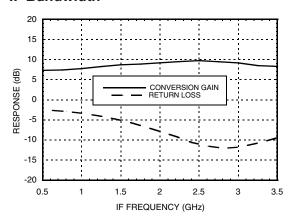


Quadrature Channel Data Taken Without IF Hybrid

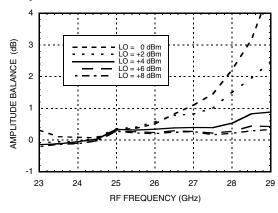
Isolations



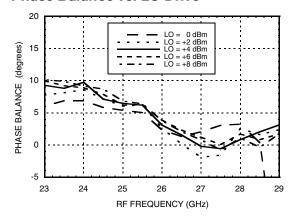
IF Bandwidth*



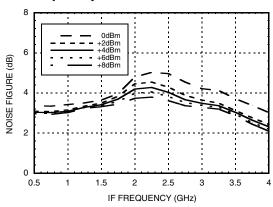
Amplitude Balance vs. LO Drive



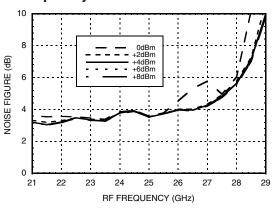
Phase Balance vs. LO Drive



Noise Figure vs. LO Drive, LO Frequency = 12 GHz



Noise Figure vs. LO Drive, IF Frequency = 100 MHz



^{*} Conversion gain data taken with external IF hybrid, LO frequency fixed at 12 GHz and RF varied



v06.0514



GaAs MMIC I/Q DOWNCONVERTER 24 - 28 GHz

MxN Spurious Outputs

	nLO				
mRF	0	1	2	3	4
0	xx	37	12	32	45
1	12	41	0	37	41
2	xx	xx	66	70	46
3	xx	xx	xx	xx	79
4	xx	xx	xx	xx	xx

RF = 25 GHz @ -20 dBm LO = 12 GHz @ +4 dBm Data taken without IF hybrid

All values in dBc below IF power level (1RF -2LO = 1 GHz)

Absolute Maximum Ratings

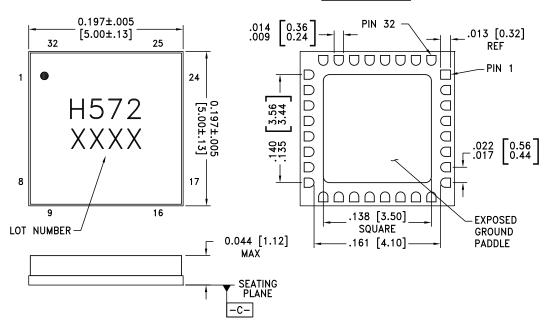
RF	+2 dBm
LO Drive	+ 13 dBm
Vdd	5.5V
Channel Temperature	175°C
Continuous Pdiss (T=85°C) (derate 9.56 mW/°C above 85°C)	860 mW
Thermal Resistance (R _{TH}) (channel to package bottom)	104.6 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C
ESD Sensitivity (HBM)	Class 1B





Outline Drawing

BOTTOM VIEW



NOTES:

- PACKAGE BODY MATERIAL: ALUMINA
- 2. LEAD AND GROUND PADDLE PLATING: 30 80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKLE
- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [2]
HMC572LC5	Alumina, White	Gold over Nickel	MSL3 [1]	H572 XXXX

^[1] Max peak reflow temperature of 260 °C

^{[2] 4-}Digit lot number XXXX



v06.0514

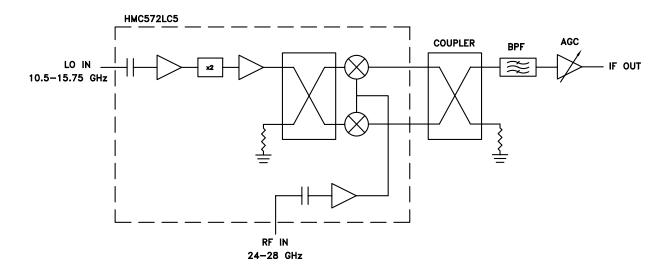


GaAs MMIC I/Q DOWNCONVERTER 24 - 28 GHz

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	VddLO	Power supply for first stage of LO amplifier.	VddLO ○ <u>↓</u> <u></u>
2, 4 - 6, 8, 9, 12 - 18, 21, 22, 25 - 28, 31, 32	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance.	
3	VddLO2	Power supply for second stage of LO amplifier.	VddLO2 ○
7	VddRF	Power supply for RF LNA.	VddRF ○
10, 19, 24, 29	GND	These pins and ground paddle must be connected to RF/DC ground.	⊖ GND =
11	RF	This pin is AC coupled and matched to 50 Ohms.	RF ○
20	IF2	This pin is DC coupled for applications not requiring operation to DC. This port should be DC blocked externally using a series capacitor whose value has	IF1,IF2 O
23	IF1	been chosen to pass the necessary frequency range. For operation to DC, this pin must not sink / source more than 3 mA of current or part non-function and possible failure will result.	
30	LO	This pin is AC coupled and matched to 50 Ohms.	10 0—

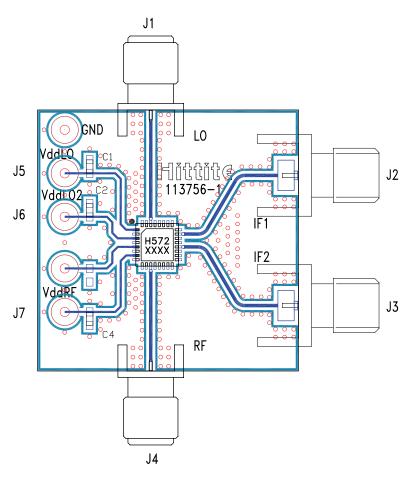
Typical Application







Evaluation PCB



List of Materials for Evaluation PCB 113758 [1]

Item	Description	
C1 - C4	Capacitor 0603, 0.01 µF	
J1, J4	PCB Mount SMA RF Connector, SRI	
J2, J3	PCB Mount SMA Connector, Johnson	
J5 - J7	DC Pin	
U1	HMC572LC5	
PCB [2]	113756 Evaluation Board	

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.







ANALOGDEVICES

GaAs MMIC I/Q DOWNCONVERTER 24 - 28 GHz

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Up-Down Converters category:

Click to view products by Analog Devices manufacturer:

Other Similar products are found below:

HMC7586-SX HMC7587 HMC8119-SX HMC7587-SX HMC6147ALC5ATR MDS-158-PIN LA8153QA-WH HMC7912LP5ETR

HMC377QS16GETR MY87C CSM2-10 CHR3762-QDG AD6620ASZ-REEL ADF5904ACPZ ADF5904WCCPZ AD6623ASZ

AD6633BBCZ AD6634BBCZ AD9957BSVZ AD9957BSVZ-REEL ADMV1009AEZ ADMV1010AEZ ADMV1011AEZ ADMV1012AEZ

ADRF6658BCPZ HMC1065LP4E HMC951ALP4E HMC571 HMC6146BLC5A HMC6146BLC5ATR HMC572LC5 HMC925LC5

HMC6787ALC5A HMC6787ALC5ATR HMC682LP6CE HMC571LC5TR HMC7911LP5E HMC7912LP5E HMC908ALC5

HMC967LP4E HMC977LP4E AD6634BBC HMC6505ALC5 MAUC-011003-TR0500 MAX9996ETP+T MAX19996AETP+

MAX19996ETP+ MAX2039ETP+ MAX2410EEI+ MAX2411AEEI+